

Appl. No. 10/785,524
Customer No. 42717

IFW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of
Kuen-Chyr Lee, et al.

Serial No.: 10/785,524

Filed: February 24, 2004

For: Method for Improving the
Electrical Continuity for a
Silicon-Germanium Film Across
a Silicon/Oxide/Polysilicon
Surface Using a Novel Two-
Temperature Process

§ Docket No.: 2001-1693 / 24061.450
§
§ Customer No. 42717
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§ Group Art Unit: 2823
§
§ Examiner: Trung Q. Dang
§
§
§

TRANSMITTAL

Mail Stop: Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

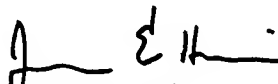
Dear Sir:

Enclosed for filing in the above-identified patent application.

1. Response to Office Action dated February 23, 2005;
2. Six Declarations under 37 CFR §1.131, signed by each inventor individually, with one copy of referenced Exhibit A;
3. Petition for Extension of Time under 37 CFR 1.136(a) for one month (in duplicate);
4. A check in the amount of \$120.00 for fees under 37 CFR 1.17(a)(1);
5. This transmittal (in duplicate); and
6. Return postcard.

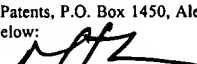
The Director is authorized to charge any deficiency fees or credit any overpayments to Deposit Account No. 08-1394 (24061.450) of Haynes and Boone, LLP.

Respectfully submitted,


James E. Harris
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Date: 6/21/05

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CERTIFICATE OF MAILING	
I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner For Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the date indicated below:	
	
Nishi Pasarya	
Date	6/21/05